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Thank you for your cooperation and understanding,

WeEn Semiconductors



SCR, 12 A, 15mA, 650 V, SOT78 Rev. 05 — 27 February 2009

Product data sheet

Product profile 1.

1.1 General description

Planar passivated SCR (Silicon Controlled Rectifier) in a SOT78 plastic package.

1.2 Features and benefits

- High reliability
- High surge current capability

1.3 Applications

- Ignition circuits
- Motor control

- High thermal cycling performance
- Protection Circuits
- Static switching

1.4 Quick reference data

Table 1 Quick reference

| Table 1. | QUICK reference | | | | | |
|---------------------|--------------------------------------|--|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{DRM} | repetitive peak off-state voltage | | - | - | 650 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{mb} ≤ 109 °C; see <u>Figure 3</u> | - | - | 7.5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 109 °C; see <u>Figure 1</u> ; see <u>Figure 2</u> | - | - | 12 | A |
| Static ch | aracteristics | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; T _j = 25 °C; I _T = 100 mA; see <u>Figure 8</u> | - | 2 | 15 | mA |



2. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|-------------|---------------------------|--------------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | К | cathode | | |
| 2 | А | anode | mb | А Ӈ К |
| 3 | G | gate | r O S | G <i>sym037</i> |
| mb | mb | anode | | |
| | | | SOT78 (TO-220AB;SC-46) | |

3. Ordering information

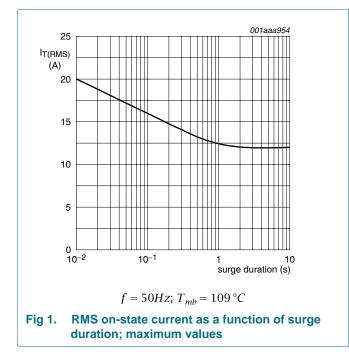
| Table 3. Orde | ring informatio | 1 | |
|---------------|--------------------|--|---------|
| Type number | Package | | |
| | Name | Description | Version |
| BT151-650R | TO-220AB; SC-46 | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

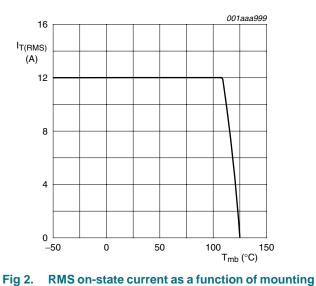
4. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|------------------------------------|--|-----|-----|------------------|
| V _{DRM} | repetitive peak off-state voltage | | - | 650 | V |
| V _{RRM} | repetitive peak reverse voltage | | - | 650 | V |
| I _{T(AV)} | average on-state current | half sine wave; $T_{mb} \le 109 \text{ °C}$; see Figure 3 | - | 7.5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{mb} ≤ 109 °C; see <u>Figure 1</u> ; see <u>Figure 2</u> | - | 12 | А |
| dl _T /dt | rate of rise of on-state current | I_T = 20 A; I_G = 50 mA; dI_G/dt = 50 mA/µs | - | 50 | A/µs |
| I _{GM} | peak gate current | | - | 2 | А |
| P _{GM} | peak gate power | | - | 5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| Tj | junction temperature | | - | 125 | °C |
| I _{TSM} | non-repetitive peak | half sine wave; t _p = 8.3 ms; T _{j(init)} = 25 °C | - | 132 | А |
| | on-state current | half sine wave; $t_p = 10 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; see Figure 4; see Figure 5 | - | 120 | А |
| l ² t | I2t for fusing | t _p = 10 ms; sine-wave pulse | - | 72 | A ² s |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| V _{RGM} | peak reverse gate voltage | | - | 5 | V |



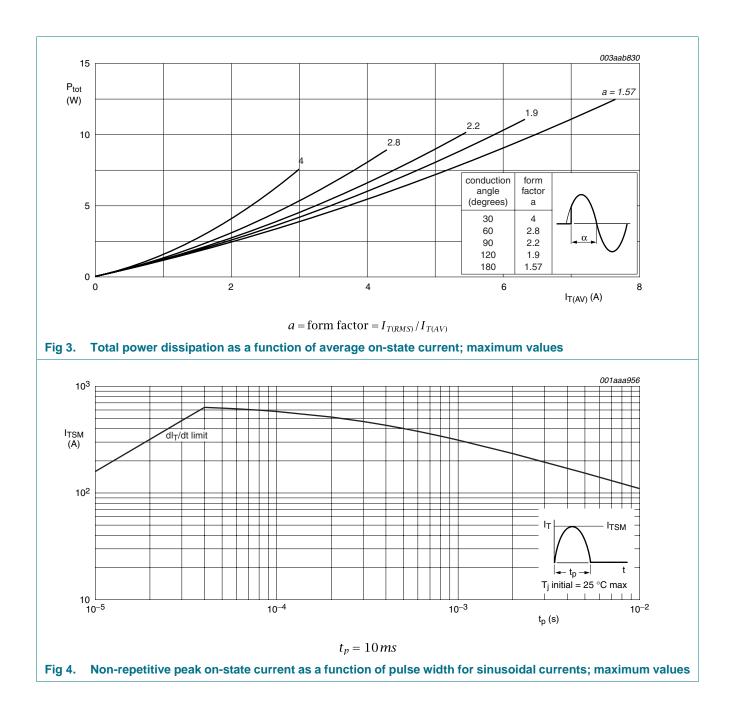


base temperature; maximum values

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BT151-650R

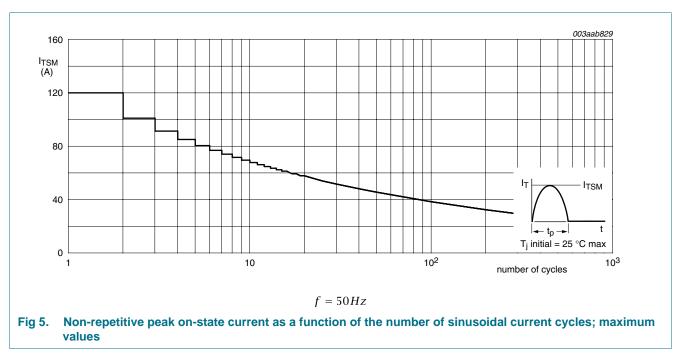
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BT151-650R

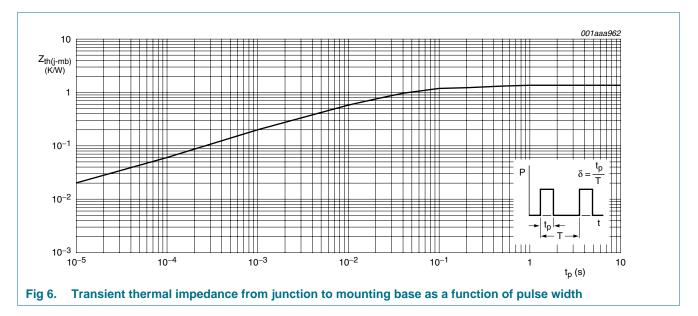
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5. Thermal characteristics

Table 5. Thermal characteristics

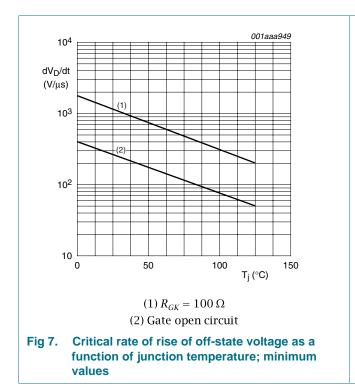
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--|---------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see <u>Figure 6</u> | - | - | 1.3 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient free air | | - | 60 | - | K/W |

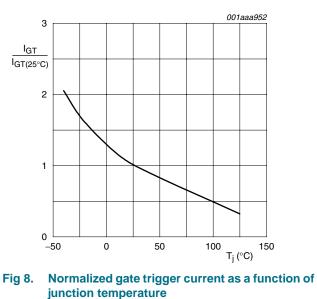


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6. Characteristics

| Table 6. | Characteristics | | | | | |
|---------------------|-----------------------------------|--|------|------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static cha | aracteristics | | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; \text{ T}_j = 25 \text{ °C}; \text{ I}_T = 100 \text{ mA}; \text{ see}$ Figure 8 | - | 2 | 15 | mA |
| ۱L | latching current | $V_D = 12 \text{ V}; \text{ T}_j = 25 \text{ °C}; \text{ see } \underline{\text{Figure 9}}$ | - | 10 | 40 | mA |
| I _H | holding current | $V_D = 12 \text{ V}; \text{ T}_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 10}{10}$ | - | 7 | 20 | mA |
| V _T | on-state voltage | I _T = 23 A; T _j = 25 °C; see <u>Figure 11</u> | - | 1.4 | 1.75 | V |
| V _{GT} | gate trigger voltage | I_T = 100 mA; V_D = 12 V; T_j = 25 °C; see Figure 12 | - | 0.6 | 1.5 | V |
| | | $I_T = 100 \text{ mA}; \text{ V}_D = 650 \text{ V}; \text{ T}_j = 125 \text{ °C}$ | 0.25 | 0.4 | - | V |
| I _D | off-state current | V _D = 650 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| I _R | reverse current | V _R = 650 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| Dynamic | characteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 435 V; T _j = 125 °C; exponential waveform; gate open circuit | 50 | 130 | - | V/µs |
| | | V_{DM} = 435 V; T _j = 125 °C; R _{GK} = 100 Ω; exponential waveform; see Figure 7 | 200 | 1000 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | $\begin{split} I_{TM} &= 40 \text{ A}; V_D = 650 \text{V}; I_G = 100 \text{mA}; \\ \text{d} I_G/\text{d} t = 5 \text{A}/\mu\text{s}; \text{T}_j = 25 ^\circ\text{C} \end{split}$ | - | 2 | - | μs |
| t _q | commutated turn-off time | | - | 70 | - | μs |

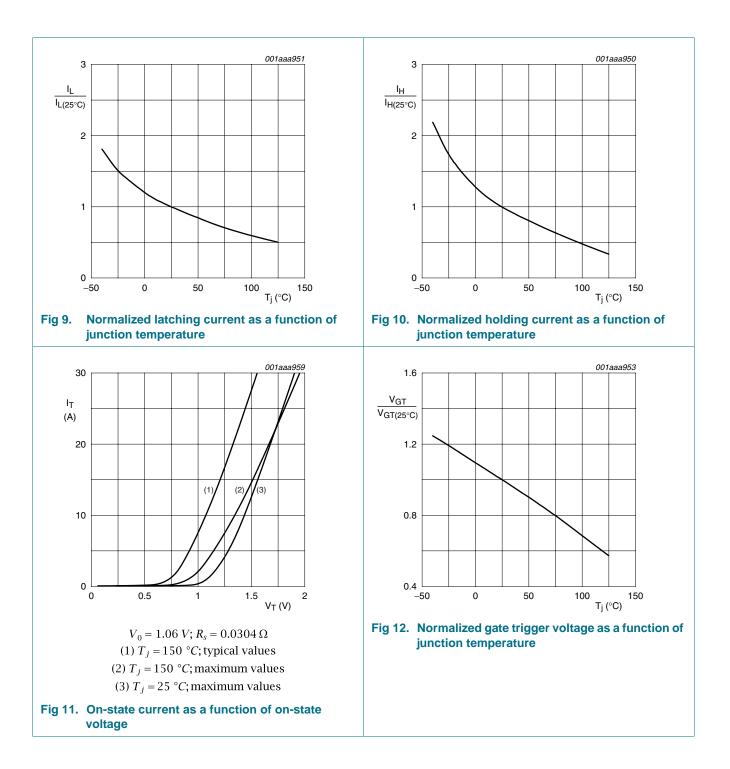




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BT151-650R

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SCR, 12 A, 15mA, 650 V, SOT78

7. Package outline

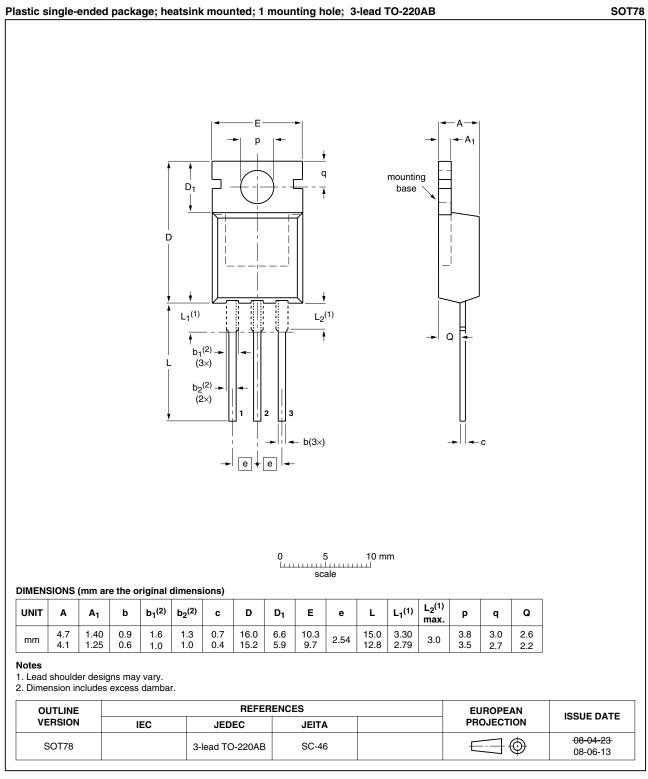


Fig 13. Package outline SOT78 (TO-220AB)

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8. Revision history

| ory | | | |
|---------------------------------|--|--|--|
| Release date | Data sheet status | Change notice | Supersedes |
| 20090227 | Product data sheet | - | BT151_SER_L_R_4 |
| Package ou | tline updated. | | |
| Type number | er BT151-650R separated | from data sheet BT151_S | SER_L_R_4. |
| 20061023 | Product data sheet | - | BT151_SERIES_3 |
| 20040607 | Product specification | - | BT151_SERIES_2 |
| 19990601 | Product specification | - | BT151_SERIES_1 |
| 10070001 | Product specification | - | |
| | Release date 20090227 • Package ou • Type number 20061023 20040607 | Release dateData sheet status20090227Product data sheet• Package outline updated.•• Type number BT151-650R separated20061023Product data sheet20040607Product specification19990601Product specification | Release date Data sheet status Change notice 20090227 Product data sheet - • Package outline updated. - - • Type number BT151-650R separated from data sheet BT151_S 20061023 Product data sheet - 20040607 Product specification - - - 19990601 Product specification - - |

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9. Legal information

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| Document status [1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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SCR, 12 A, 15mA, 650 V, SOT78

11. Contents

| 1 | Product profile1 |
|-----|--------------------------|
| 1.1 | General description1 |
| 1.2 | Features and benefits1 |
| 1.3 | Applications1 |
| 1.4 | Quick reference data1 |
| 2 | Pinning information2 |
| 3 | Ordering information2 |
| 4 | Limiting values3 |
| 5 | Thermal characteristics5 |
| 6 | Characteristics6 |
| 7 | Package outline8 |
| 8 | Revision history9 |
| 9 | Legal information10 |
| 9.1 | Data sheet status10 |
| 9.2 | Definitions10 |
| 9.3 | Disclaimers |
| 9.4 | Trademarks |
| 10 | Contact information10 |

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